

SD4590

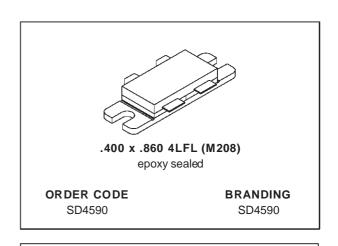
RF & MICROWAVE TRANSISTORS 800-960 MHz CELLULAR BASE STATION

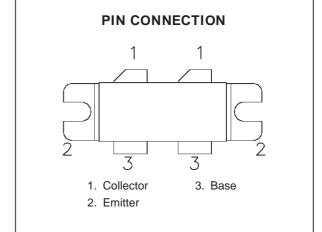
- GOLD METALLIZATION
- DIFFUSED EMITTER BALLASTING
- INTERNAL INPUT/OUTPUT MATCHING
- COMMON EMITTER CONFIGURATION
- DESIGNED FOR LINEAR OPERATION
- HIGH SATURATED POWER CAPABILITY
- 26 VOLT, 900 MHz PERFORMANCE

 POUT = 150 W MIN.

 GAIN = 8.5 dB MIN.

 IMD₃ = -28dB MAX. @ POUT = 150W PEP
- INHERENT RUGGEDNESS: LOAD MISMATCH TOLERANCE OF 5:1 MIN. VSWR 3 dB OVERDRIVE CAPABILITY





DESCRIPTION

The SD4590 is designed for both analog and digital cellular base stations over the 800 to 960 MHz frequency range, specifically those systems requiring the high linearity and efficiency afforded by class AB operation. Integrated input/output prematching simplifies amplifier design. Ruggedness, MTTF, and linearity are enhanced using diffused emitter resistors and refractory/gold metallization.

ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
Vсво	Collector-Emitter Voltage	65	V
V _{CEO}	Collector-Emitter Voltage	28	V
V _{EBO}	Emitter-Base Voltage	3.5	V
Ic	Device Current	25	A
P _{DISS}	Power Dissipation	300	W
TJ	Junction Temperature	+200	°C
T _{STG}	Storage Temperature	- 65 to +150	°C

THERMAL DATA

R _{TH(j-c)} Junction-Case Thermal Resistance	0.60	°C/W
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January 22, 1998

ELECTRICAL SPECIFICATIONS (Tcase = 25°C)

STATIC

Symbol		Test Conditions		Value Min. Typ. Ma			Unit
		rest conditions				Max.	
BV _{CBO}	I _C = 50mA	$V_{BE} = 0V$		65	80	_	V
BVCEO	I _C = 100mA	$I_B = 0mA$		28	30	_	V
BV _{CER}	I _C = 100mA	$R_{BE} = 75\Omega$		33	40	_	V
BV _{EBO}	I _E = 10mA	$I_C = 0mA$		3.5	4.0	_	V
I _{CEO}	$V_{CE} = 30V$	$V_{BE} = 0V$			_	10	mA
h _{FE}	$V_{CE} = 5V$	$I_C = 6A$		25	45	120	_

Tested per side

DYNAMIC

Symbol	Test Conditions	Value			Unit
	rest Conditions	Min. Typ. Max.	Oiiit		
C _{OB}	$f = 1.0 \text{ MHz}$ $V_{CB} = 26 \text{ V}$	_	75	_	pF
	for information only - this part is collector matched				

Tested per side

DYNAMIC (CW)

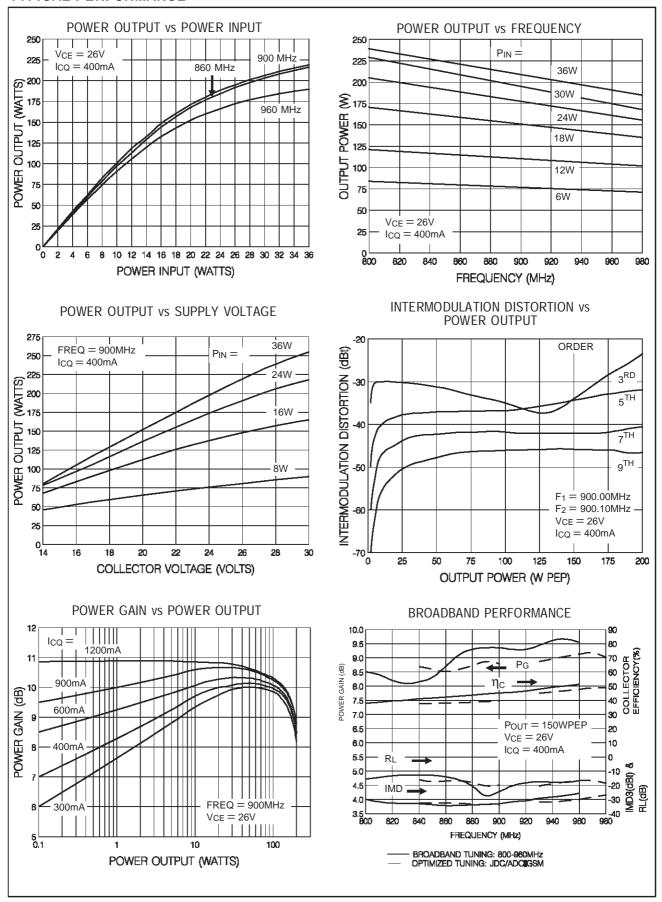
Symbol	Test Conditions	Value Ui		Unit	
Symbol	rest conditions			Oiiit	
PiN	$f = 900MHz$ $V_{CE} = 26V$ $I_{CQ} = 2 \times 200mA$ $P_{OUT} = 150W$			21	W
Pout	$f = 900MHz$ $V_{CE} = 26V$ $I_{CQ} = 2 \times 200mA$ $P_{IN} = 21W$	150	175		W
GP	$f = 900MHz$ $V_{CE} = 26V$ $I_{CQ} = 2 \times 200mA$ $P_{OUT} = 150W$	8.5	9.5		dB
ης	$f = 900MHz$ $V_{CE} = 26V$ $I_{CQ} = 2 \times 200mA$ $P_{OUT} = 150W$	50	55	_	%
P _{1dB}	$f = 900MHz$ $V_{CE} = 26V$ $I_{CQ} = 2 \times 200mA$	150	160		W
OVD		No Degradation in Device Performance			evice

DYNAMIC (Two-Tone)

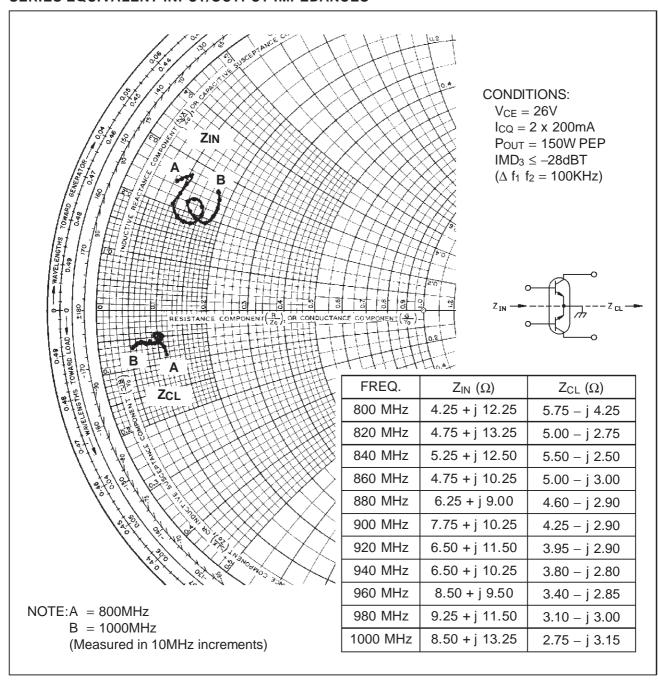
Symbol		Test Condition:	•	Value Min. Typ. Max.		Unit	
		rest Conditions	•			Oiiit	
*G _P	V _{CE} = 26V	$I_{CQ} = 2 \times 200 \text{mA}$	P _{OUT} = 150W PEP	8.5	9.5		dB
*η _C	V _{CE} = 26V	$I_{CQ} = 2 \times 200 \text{mA}$	Pout = 150W PEP	30	35	_	%
*IMD ₃	V _{CE} = 26V	$I_{CQ} = 2 \times 200 \text{mA}$	P _{OUT} = 150W PEP	1	-32	-28	dBT
*Load Mismatch	V _{CE} = 26V VSWR = 5:1 I	I _{CQ} = 2 x 200mA MIN @ All phase angle	P _{OUT} = 150W PEP	No Degradation in Device Performance			evice
*OVD	$V_{CE} = 26V$ $I_{CQ} = 2 \times 200 \text{mA}$ Set $P_{OUT} = 150 \text{W PEP}$; Increase P_{IN} 3dB			No [_	ion in De mance	evice

*Note: $f_1 = 900.00 \text{ MHz}$ $f_2 = 900.10 \text{ MHz}$

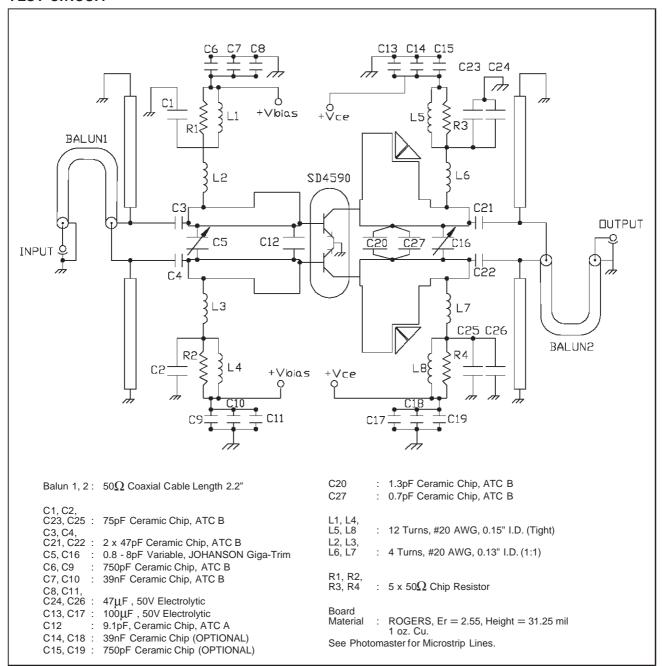
TYPICAL PERFORMANCE



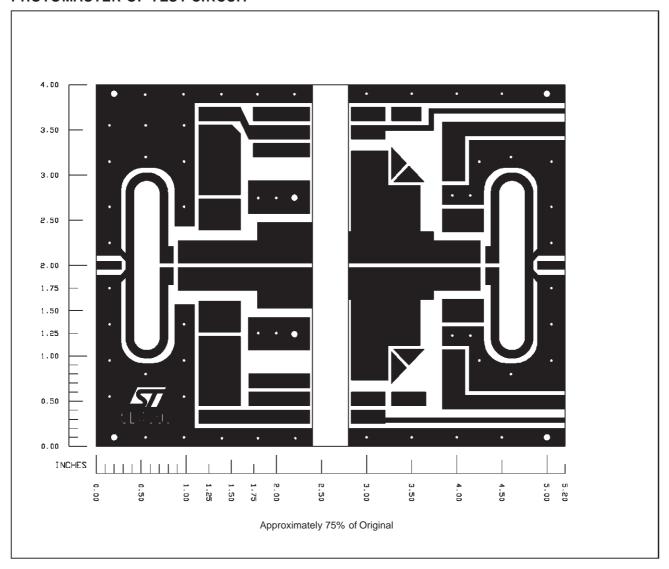
SERIES EQUIVALENT INPUT/OUTPUT IMPEDANCES



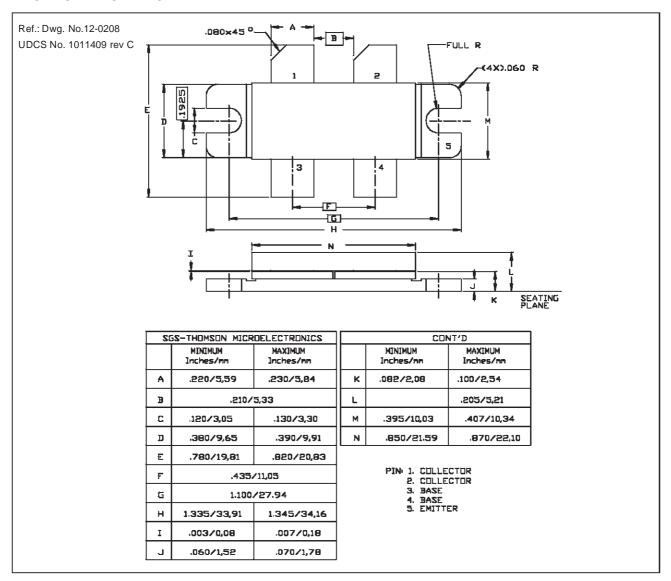
TEST CIRCUIT



PHOTOMASTER OF TEST CIRCUIT



PACKAGE MECHANICAL DATA



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